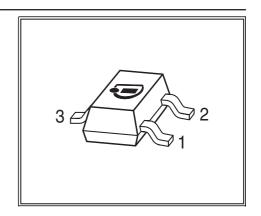


#### **NPN Silicon RF Transistor**

- For linear broadband amplifier application up to 500 MHz
- SAW filter driver in TV tuners
- Pb-free (RoHS compliant) package





Туре	Marking	Pin Configuration Package			
BF799	LKs	1 = B	2 = E	3 = C	SOT23

## **Maximum Ratings**

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	$V_{\sf CEO}$	20	V	
Collector-emitter voltage	$V_{CES}$	30		
Collector-base voltage	$V_{\mathrm{CBO}}$	30		
Emitter-base voltage	$V_{EBO}$	3		
Collector current	I <sub>C</sub>	35	mA	
Peak collector current,	/ <sub>CM</sub>	50		
Peak base current	/ <sub>BM</sub>	15		
Total power dissipation	P <sub>tot</sub>	280	mW	
$T_{\rm S} \le 69  ^{\circ}{\rm C}^{1)}$				
Junction temperature	$T_{i}$	150		
Storage temperature	$T_{\rm stq}$	-65 150		

Junction - soldering point <sup>2)</sup>	R <sub>thJS</sub>	≤ 290	K/W

 $<sup>{}^{1}</sup>T_{\mathrm{S}}$  is measured on the collector lead at the soldering point to the pcb

 $<sup>^2</sup>$ For calculation of  $R_{thJA}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

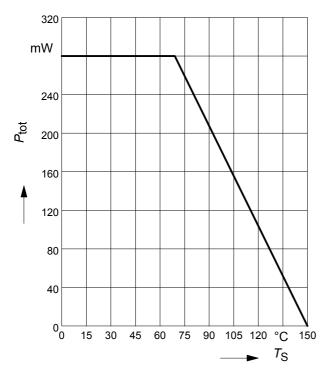


**Electrical Characteristics** at  $T_A$  = 25 °C, unless otherwise specified.

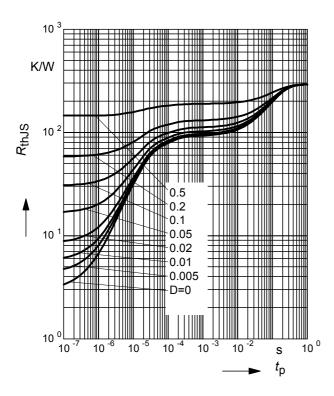
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC characteristics	•				
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	20	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	30	-	-	
$I_{\rm C}$ = 10 $\mu$ A, $I_{\rm E}$ = 0					
Base-emitter breakdown voltage	$V_{(BR)EBO}$	3	-	-	
$I_{\rm E}$ = 10 $\mu$ A, $I_{\rm C}$ = 0					
Collector-base cutoff current	/ <sub>CBO</sub>	-	-	100	nA
$V_{\text{CB}} = 20 \text{ V}, I_{\text{E}} = 0$					
DC current gain	h <sub>FE</sub>				-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 10 V		35	95	_	
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 10 V		40	100	250	
Collector-emitter saturation voltage	V <sub>CEsat</sub>	-	0.1	0.3	V
$I_{\rm C}$ = 20 mA, $I_{\rm B}$ = 2 mA					
Base-emitter saturation voltage	V <sub>BEsat</sub>	-	-	0.95	]
$I_{\rm C}$ = 20 mA, $I_{\rm B}$ = 2 mA					
AC characteristics					
Transition frequency	f <sub>T</sub>				MHz
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 10 V, $f$ = 100 MHz		-	800	-	
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 8 V, $f$ = 100 MHz		-	1100	-	
Output capacitance	C <sub>ob</sub>	-	0.96	-	pF
$V_{\text{CB}} = 10 \text{ V}, I_{\text{E}} = 0 \text{ mA}, f = 1 \text{ MHz}$					
Collector-base capacitance	C <sub>cb</sub>	-	0.7	-	1
$V_{\rm CB}$ = 10 V, $f$ = 1 MHz					
Collector-emitter capacitance	C <sub>ce</sub>	-	0.28	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}$					
Noise figure	F	-	3	-	dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 10 V, $f$ = 100 MHz,					
$Z_{\rm S}$ = 50 $\Omega$					
Output conductance	g <sub>22e</sub>	-	60	-	μS
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 10 V, $f$ = 35 MHz					



# Total power dissipation $P_{tot} = f(T_S)$

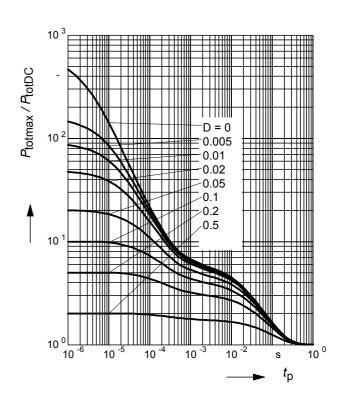


# Permissible Pulse Load $R_{\mathrm{thJS}}$ = $f\left(t_{\mathrm{p}}\right)$



## **Permissible Pulse Load**

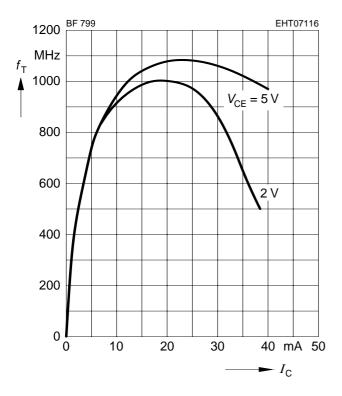
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$$



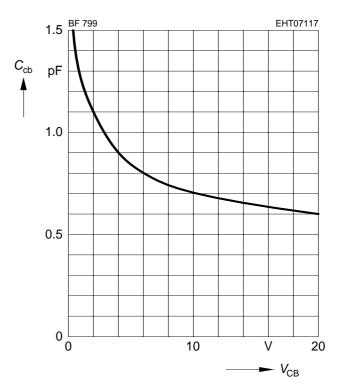


# Transition frequency $f_T = f(I_C)$

*f* = 100MHz

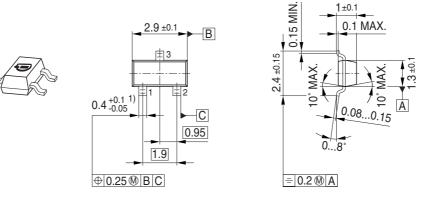


# Collector-base capacitance $C_{CD} = f(V_{CB})$ f = 1 MHz



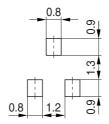


## Package Outline

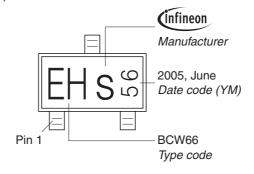


1) Lead width can be 0.6 max. in dambar area

## Foot Print

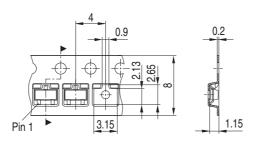


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





#### Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

#### Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

#### Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<a href="www.infineon.com">www.infineon.com</a>).

#### Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

6

2011-09-21